Spec Code

SC-010006400

SPECIFICATIONS

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SEIKO EPSON CORPORATION LCD DIVISION

> LD DESIGN Dep. Ç Uslishorhi Drus J. Waynelin M. Mignedita

1. Basic Specificatio	ons
1-1 Display Specifi	cations
(1) STN Mode Posit:	ive Display type Reflective Wodel
(2) Display Color	
Display Color Background Colo	: Display Data"1" : Dark Blue pr : Display Data"0" : Gray
(3) Viewing Angle	: 6 O'clock direction
(4) Driving Duty	: 1/64 Duty
	is slightly changed by temperature and driving voltage.
-2 Mechanical Speci	
	ons : Refer to attached Outline Dimensions figure SD $-$ 0 1 0 0 7 3 $-$ A
(2) Dot Matrix	: 256 dots \times 128 dots
(3) Dot Size	0.43 (W) × 0.43 (H) (mm)
(4) Dot Pitch	: 0.47 (W) × 0.47 (H) (mm)
(5) Weight	: 190g (Typ.)
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SEIKO	DEPSON CORPORATION Sheet Code 11-01000640
	Code 11-01000640



1-4 Terminal Functions

Pin No.	Symbol	Function				
1	VDD	Power supply for logic				
2	VSS	Ground				
3	VLCD	Power supply for LCD				
4	LP	Latch pulse signal input				
5	FR	Switch signal input to convert LC drive waveform to AC				
6	YDIS	Display control (Display off "O",Normal state "1")				
7	Y SCL	Row scan shift clock input				
8	DIN	Row scan start-up pulse input				
9	X SCL	Display data shift clock input				
10	X ECL	Enable transition clock input				
1 1 $\widetilde{}$ 1 4	D 0 ~ D 3	Display data pulse input				



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2. Absolute Maximum Ratings

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Item	Symbol	Standard Value	Unit	Condition	
Power supply Voltage	VDD – VSS	0 ~ + 7.0			
LCD Driving Voltage	V DD – V LCD	$0 \sim +25.0$	v		
Input Voltage	VIN	$VSS \leq VIN \leq VDD$			
Operating Temperature Range	Т ОР	0 ~ + 5 0			
Storage Temperature Range	TST	$-20 \sim +60$	°C	Not to be dewy	

3. Electrical Characteristics

3-1 DC Characteristics

(1) Module DC Characteristics

 $T a = 0 \sim 5 0$ °C, $V DD = 5 V \pm 5$ %

				1 6	a = 0 ~	∕50°C, VDD	= 5 V ± 5 9
Item	Symbol	St	tandard Va	lue			1
	Gymbol	MIN TYP MAX		MAX	- Unit	Applicable Terminal	Condition
Power Supply	V DD	4. 75	5.0	5.25		VDD	
Voltage	VDD-VLCD	Depending Optical C	on Characteris	tics		VLCD	
"O"Input Voltage	VIL	0	_	0. 2VDD		LP, FR	
"1"Input Voltage	VIH	0. 8VDD	-	VDD	v	YDIS, YSCL DIN, XSCL	
I/O Leak Current	11	-	-	50	μΑ	XECL D0~D3	
Power Supply Current	I DD	-	-	5.5	mA	VDD	<u> </u>
LCD Power Supply Current	I LCD	-	-	4.0	m A	VLCD	*1

*1) VLCD=-8V, Frame Frequency 75Hz

3-2 AC Characteristics

Item	Symbol	5	Standard V	alue		
		MIN	TYP	MA	X Uni	t Condition
Allowable F R Delay Time	TFD	- 5 0 0	0	50	0 nse	=
LP, YSCL Period	TLC		220		μ sec	
XSCL Period	TXSC	166	-	-	nsec	
YSCL "L" Time	TSL	180			лзес	
YSCL Pulse Width	WYSC	180	-		nsec	
LP "L" Time	TLL	220			nsec	-}
LP Pulse Widhte	WLP	250	_		лѕес	-1
XECL "L" Time	TEL	100		<u> </u>	лзес	
XECL Pulse Width	WECL	100			nsec	
XSCL″L″Time	TXSL	63			nsec	
XSCL Pulse Width	WXSC	63	-		nsec	
XECL Setup Time	TL1	140	-		nsec	VDD=
XECL Hold Time	TL2	50			nsec	5 V
	TLT1	125				
Latch Timing	TLT2	0		— <u>—</u>	-	
a constructing	TLS1	100			nsec	
·	TLS2	0			-	
XECL Switching Time ("H")	TS1	70	-		пѕес	•
XECL Switching Time	TS2	- 1 0	-		nsec	1
ata Setup Time	TDS	50			nsec	
ata Nold Time	ТОН	30			nsec	
DIN Setup Time	TDIS	100			nsec	
DIN Hold Time	TDIH	30			<u>}</u> {	
nput ¥ave Form ise Time	tr	-	-	× 1	nsec nsec	
nput Wave Form	tf			× 1	лѕес	

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1: 1	1.					T	1
		2 1: 3		1:253	1:254	1:255	1:25
2: 1	2: 2	2 2: 3	3 .		2:254	2:255	2:25
3: 1	3: 2	2 .				3:255	3:250
4: 1	. 						4:256
61: 1					· ·	 .	61:256
62: 1	62: 2					62:255	62:256
63: 1	63: 2	63: 3		•	63:254	63:255	63:256
64: 1	64: 2	64: 3	64: 4	64 : 253	64:254	64:255	64:256
1:257	1:258	1:259	1:260	1:509	1:510	1:511	1:512
2:257	2:258	2:259	•		2:510	2:511	2:512
3:257	3:258		•			3:511	3:512
4:257	•	•					4:512
61:257							61:512
62:257	62:258					62:511	62:512
63:257	63:258	63:259			63:510	63:511	63:512
64:257	64:258	64:259	64:260	64:509	64:510	64:511	64:512

3-5 Relation between Data and Display

SFIKO FPSON

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4. Optical Characteristics

4-1 Optical Characteristics

f FR = 75 H z

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Item	Symbol	Tomp	St	andard Val	ue	11-24		
item	Symbol	Temp °C	MIN TYP MAX		MAX	Unit	Condition	
		0	-	14.6	15.6			
Driving Voltage	V OP	2 5	-	13.6	-	v		
		50	11.3	12.3	-	1		
	Tr	0	-	300	600			
Response Time		25	-	100	200			
	Τf	0	-	500	1000	ms		
		25	_	150	300			
	θΥ1		20	_	<u> </u>			
Viewing Angle	θY2	25	30	_				
viewing Angle	θX1	20	25	-	_	DEG	K ≧ 2	
	θX2		25	-	_			
Contrast	К	25	_	3	<u> </u>			

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*1) Vop=LCD Driving Voltage getting maximum contrast = YDD-VLCD

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[Specification of Equipments and Measuring Condition] Luxmeter: Canon LC-3S Brightness Measurement Spot Diameter φ2mm

Lighting Source : Halogen Lamp(Circular)

(2) Definition of Viewing Angle



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Sheet Code 42-AN000002





5. Reliability

5-1 Content of Reliability Test

Envi	ronmental	Test
D117 ¥	rounchear	ICSL

Test Item	Conntent of Test	Test Condition	Applicable standard
lligh temperature storage	Endurance test applying the high storage temperature for a long time.	60 ℃ 200 II	· · · · · · · · · · · · · · · · · · ·
Low temperature storage	Endurance test applying the low storage temperature for a long time.	-20 ℃ 200 H	
High temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50 ℃ 200 II	
Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	0 ℃ 200 H	
High temperature/ humidity storage	Endurance test applying the high temperature and high humidity storage for a long time.	60 ℃ 90 %RH 96 II	MIL-202E-103B JIS-C5023
lligh temperature/ humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature/humidity stress to the element for a long time.	50 ℃ 90 %RH 96 H	MIL-202E-103B JIS-C5023
Temperature cycle	Endurance test applying the low and high temperature cycle. $-20^{\circ}C \iff 25^{\circ}C \iff 60^{\circ}C \iff 25^{\circ}C$ $30^{\circ}min.$ $5^{\circ}min.$ $30^{\circ}min.$ $5^{\circ}min.$	-20°C/60°C 10 cycle	
· · · · · · · · · · · · · · · · · · ·	l cycle		
	Mechanical Test	· · ·	<u> </u>
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz →1.5G Total 0.5H	M1L-202E-201A J1S-C5025 J1S-C7022-A-10
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave llmsec 3 times of each , direction	MIL-202Er213B
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115 mbar 40 H	MIL-202E-105C
	Others	· · · · · · · · · · · · · · · · · · ·	
Static electricity test	Endurance test applying the electric stress to the terminal.	VS = 800 v $RS = 1.5 k\Omega$ CS = 100 PF 1 time	MIL-883B-3015.1
l'Ower supply y	oltage for logic system - 5V	mum Contrast at 25°C	
	High temperature storage Low temperature storage High temperature Operation Low temperature operation High temperature/ humidity storage High temperature/ humidity operation Temperature cycle Vibration test Shock test Shock test Atmospheric pressure test Static electricity test *1) Driving conditi Power supply y	High temperature storageEndurance test applying the high storage temperature for a long time.Low temperature OperationEndurance test applying the low storage temperature for a long time.High temperature OperationEndurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.Low temperature operationEndurance test applying the electric stress under low temperature for a long time.Low temperature operationEndurance test applying the electric stress under low temperature for a long time.High temperature/ humidity storageEndurance test applying the high temperature and high humidity storage for a long time.High temperature/ humidity operationEndurance test applying the electric stress (Voltage & Current) and temperature/humidity stress to the element for a long time.Temperature cycleEndurance test applying the low and high temperature cycle. -20°C <> 25°C <> 60°C <> 25°C 30min.Temperature cycleEndurance test applying the low and high temperature cycle. -20°C <> 25°C <> 60°C <> 25°C 30min.Shock testConstructional and mechanical endurance test applying the stress of the shock during transportation.Atmospheric pressure testEndurance test applying the stress to the test applying the electric stress to the terminal.*1) Driving condition for operation test Power supply vpl tage for polying test*1) Driving condition for operation test Power supply vpl tage for logic current of test	Night temperature storageEndurance test applying the high storage temperature for a long time.60 °C 200 HLow temperature StorageEndurance test applying the low electric stress (Voltage & Current) and the thermal stress to the electric stress (Voltage & Current) and the thermal stress to the electric stress under low temperature for a low temperature/ peration50 °C 200 °C 90 %RH 96 °C

5-2 Failure Judgement Criterion

Criterrion				ſest	lter	n No.						
ltem	1	2	3	4	5	6	7	8	9	10	11	Failure Judgment Criterion
Basic Specification	0	0	0	0	0	0	0	0	0	0	0	Out of the Basic Specification
Electrical characteristic	0		0	0	0	0					0	Out of the DC and AC Characteristic
Mechanical characteristic						0	0	0	0			Out of the Mechanical Specification Color change : Out of Limit Apperance Specification
Optical characteristic	0	0	0	0	0	0	0			0	0	Out of the Apperance Standard

6. Package Specifications

6-1 Inner Carton Box

Each LCD module is wrapped with a antistatic pouch, and put into the inner carton box for containing 10 pcs of LCD module.

The following contents should be indicated on the inner carton box.

Туре	E G 4 4 0 1 S – A R
Q'ty	10pcs.
Lot	Lot No.
EPSON	SEIKO EPSON CORP.
EFSUN	DISPLAY DIVISION



Fig.1 Outline of Inner Carton Box

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Code 61-010006400

Sheet

6-2 Master Carton Box

The master carton box is for sending to each user. The master carton box contains 6 pcs of inner carton box. The indications are applied to four faces A, B, C and D of the master carton as shown Fig. 1 below.



Fig.1 Outline of Master Carton Box



	Precautions for use of LCD Modules			
	<handling precautions=""></handling>			
	 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc. 			
	 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth. If the substance comes into contact with your skin or clothes, promptly wash it off using soap and water. 			
	 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. 			
	 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. 			
	 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents. 			
	- Isopropyl alcohol - Ethyl alcohol			
	Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following.			
	- Water - Ketone - Aromatic solvents			
	 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelarated by water droplets, moisture condensation or a current flow in a high-humidity environment. 			
	 Install the LCD Module by using the mounting holes. When mounting the LCD Module make sure that it is free of twisting, warping, and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable. 			
	• Do not attempt to disassemble or process the LCD Module.			
	• NC terminal should be open. Do not connect anything.			
	• If the logic circuit power is off, do not apply the input signals.			
	SEIKOEPSON CORPORATION Sheet Code B-PNNN0000-A(1)			

- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - · Be sure to ground the body when handling the LCD Modules.
 - Tools required for assembly, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - The LCD Module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

<Storage Precautions>

• When storing the LCD Modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature/normal humidity conditions (avoid high temperature/ high humidity and low temperatures below 0 °C). Whenever possible, the LCD Modules should be stored in the same conditions in which they were shipped from our comany.

<Design Precaustions>

- The absolute maximum ratings represents the rated value beyond which LCD Modules cannot exceed. When the LCD Modules are used in excess of this rated value, their operating characteristics may be adversely affected.
- To prevent the occurrence of erroneous operation caused by noise, attention must be paied to satisfy VIL, VIH, and the other specification values, including taking the precaution of using signal cables that are short.
- The liquid crystal display exhibits temperature dependency characteristics. Since recognition of the display becomes difficult when the LCD is used outside its designated operating temperature range, be sure to use the LCD within this range. Also, keep in mind that the voltage levels necessary for clear displays (Vop) will vary according to temperature.
- If DC is impressed on the liquid crystal display panel, display definition is rapidly deteriorated by the electrochemical reaction that occurs inside the liquid crystal panel. To eliminate the opportunity of DC impressing, be sure to maintain the AC characteristics of the input signals sent to the LCD Module (especially, LP, DIN, and FR).



<Others>

- Liquid crystals solidify under low temperatures (below the storage temperature range) leading to defective orientation or the generation of air bubbles (balck or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD Modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time.
 - It should be noted that this phenominon does not advesely affect performance reliability.
- To minimize the performance degradation of the LCD Modules resulting from destruction caused by static electricity. etc., exercise care to avoid holding the following sections when handling the modules.
 - Exposed area of the printed circuit board
 - Terminal electrode sections

Sheet

Code | B - PNNN0000-A(4)

REV.	Revision Items	Date
	NEW	1993. 01. 09
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